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Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	-
Peripherals	POR, WDT
Number of I/O	12
Program Memory Size	768B (512 x 12)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	25 x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	18-DIP (0.300", 7.62mm)
Supplier Device Package	18-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16c54c-20i-p

PIC16C5X

NOTES:

4.0 OSCILLATOR CONFIGURATIONS

4.1 Oscillator Types

PIC16C5Xs can be operated in four different oscillator modes. The user can program two configuration bits (FOSC1:FOSC0) to select one of these four modes:

1. LP: Low Power Crystal
2. XT: Crystal/Resonator
3. HS: High Speed Crystal/Resonator
4. RC: Resistor/Capacitor

Note: Not all oscillator selections available for all parts. See Section 9.1.

4.2 Crystal Oscillator/Ceramic Resonators

In XT, LP or HS modes, a crystal or ceramic resonator is connected to the OSC1/CLKIN and OSC2/CLKOUT pins to establish oscillation (Figure 4-1). The PIC16C5X oscillator design requires the use of a parallel cut crystal. Use of a series cut crystal may give a frequency out of the crystal manufacturers specifications. When in XT, LP or HS modes, the device can have an external clock source drive the OSC1/CLKIN pin (Figure 4-2).

FIGURE 4-1: CRYSTAL/CERAMIC RESONATOR OPERATION (HS, XT OR LP OSC CONFIGURATION)

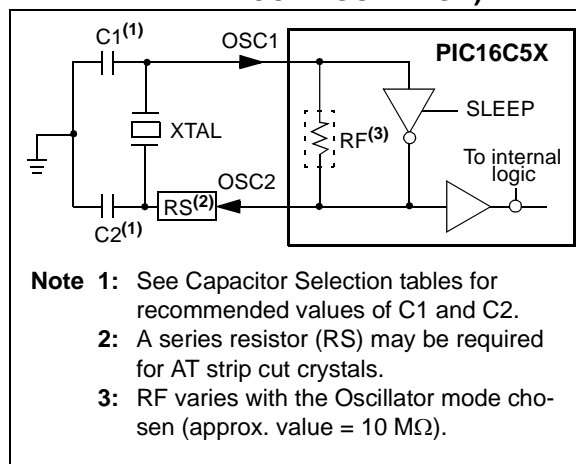


FIGURE 4-2: EXTERNAL CLOCK INPUT OPERATION (HS, XT OR LP OSC CONFIGURATION)

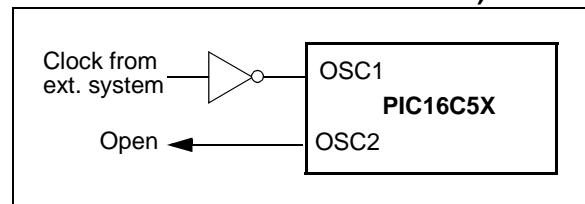


TABLE 4-1: CAPACITOR SELECTION FOR CERAMIC RESONATORS - PIC16C5X, PIC16CR5X

Osc Type	Resonator Freq	Cap. Range C1	Cap. Range C2
XT	455 kHz	68-100 pF	68-100 pF
	2.0 MHz	15-33 pF	15-33 pF
	4.0 MHz	10-22 pF	10-22 pF
HS	8.0 MHz	10-22 pF	10-22 pF
	16.0 MHz	10 pF	10 pF

These values are for design guidance only. Since each resonator has its own characteristics, the user should consult the resonator manufacturer for appropriate values of external components.

TABLE 4-2: CAPACITOR SELECTION FOR CRYSTAL OSCILLATOR - PIC16C5X, PIC16CR5X

Osc Type	Crystal Freq	Cap. Range C1	Cap. Range C2
LP	32 kHz ⁽¹⁾	15 pF	15 pF
XT	100 kHz	15-30 pF	200-300 pF
	200 kHz	15-30 pF	100-200 pF
	455 kHz	15-30 pF	15-100 pF
	1 MHz	15-30 pF	15-30 pF
	2 MHz	15 pF	15 pF
	4 MHz	15 pF	15 pF
HS	4 MHz	15 pF	15 pF
	8 MHz	15 pF	15 pF
	20 MHz	15 pF	15 pF

Note 1: For VDD > 4.5V, C1 = C2 ≈ 30 pF is recommended.

These values are for design guidance only. Rs may be required in HS mode as well as XT mode to avoid overdriving crystals with low drive level specification. Since each crystal has its own characteristics, the user should consult the crystal manufacturer for appropriate values of external components.

Note: If you change from this device to another device, please verify oscillator characteristics in your application.

5.1 Power-On Reset (POR)

The PIC16C5X family incorporates on-chip Power-On Reset (POR) circuitry which provides an internal chip RESET for most power-up situations. To use this feature, the user merely ties the $\overline{\text{MCLR}}/\text{VPP}$ pin to VDD . A simplified block diagram of the on-chip Power-On Reset circuit is shown in Figure 5-1.

The Power-On Reset circuit and the Device Reset Timer (Section 5.2) circuit are closely related. On power-up, the RESET latch is set and the DRT is RESET. The DRT timer begins counting once it detects $\overline{\text{MCLR}}$ to be high. After the time-out period, which is typically 18 ms, it will RESET the reset latch and thus end the on-chip RESET signal.

A power-up example where $\overline{\text{MCLR}}$ is not tied to VDD is shown in Figure 5-3. VDD is allowed to rise and stabilize before bringing $\overline{\text{MCLR}}$ high. The chip will actually come out of reset T_{DRT} msec after $\overline{\text{MCLR}}$ goes high.

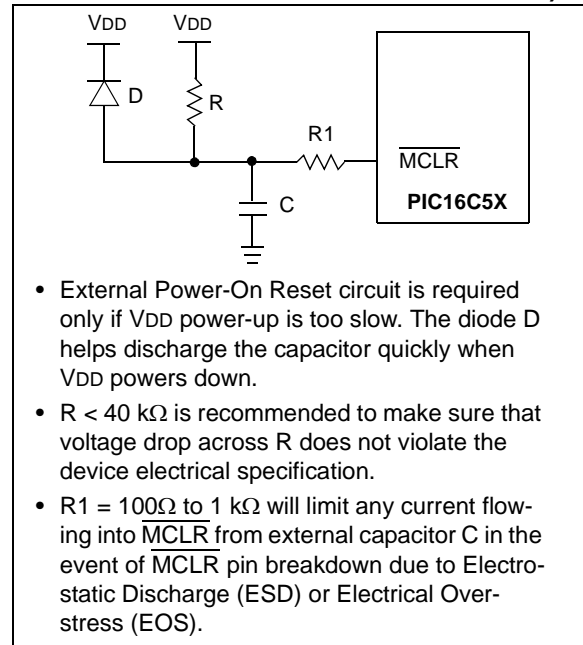
In Figure 5-4, the on-chip Power-On Reset feature is being used ($\overline{\text{MCLR}}$ and VDD are tied together). The VDD is stable before the start-up timer times out and there is no problem in getting a proper RESET. However, Figure 5-5 depicts a problem situation where VDD rises too slowly. The time between when the DRT senses a high on the $\overline{\text{MCLR}}/\text{VPP}$ pin, and when the $\overline{\text{MCLR}}/\text{VPP}$ pin (and VDD) actually reach their full value, is too long. In this situation, when the start-up timer times out, VDD has not reached the $\text{V}_{\text{DD}}(\text{min})$ value and the chip is, therefore, not guaranteed to function correctly. For such situations, we recommend that external RC circuits be used to achieve longer POR delay times (Figure 5-2).

Note: When the device starts normal operation (exits the RESET condition), device operating parameters (voltage, frequency, temperature, etc.) must be met to ensure operation. If these conditions are not met, the device must be held in RESET until the operating conditions are met.

For more information on PIC16C5X POR, see *Power-Up Considerations* - AN522 in the [Embedded Control Handbook](#).

The POR circuit does not produce an internal RESET when VDD declines.

FIGURE 5-2: EXTERNAL POWER-ON RESET CIRCUIT (FOR SLOW VDD POWER-UP)



6.0 MEMORY ORGANIZATION

PIC16C5X memory is organized into program memory and data memory. For devices with more than 512 bytes of program memory, a paging scheme is used. Program memory pages are accessed using one or two STATUS Register bits. For devices with a data memory register file of more than 32 registers, a banking scheme is used. Data memory banks are accessed using the File Selection Register (FSR).

6.1 Program Memory Organization

The PIC16C54, PIC16CR54 and PIC16C55 have a 9-bit Program Counter (PC) capable of addressing a 512 x 12 program memory space (Figure 6-1). The PIC16C56 and PIC16CR56 have a 10-bit Program Counter (PC) capable of addressing a 1K x 12 program memory space (Figure 6-2). The PIC16C57, PIC16C58 and PIC16CR58 have an 11-bit Program Counter (PC) capable of addressing a 2K x 12 program memory space (Figure 6-3). Accessing a location above the physically implemented address will cause a wraparound.

A NOP at the RESET vector location will cause a restart at location 000h. The RESET vector for the PIC16C54, PIC16CR54 and PIC16C55 is at 1FFh. The RESET vector for the PIC16C56 and PIC16CR56 is at 3FFh. The RESET vector for the PIC16C57, PIC16CR57, PIC16C58, and PIC16CR58 is at 7FFh. See Section 6.5 for additional information using CALL and GOTO instructions.

FIGURE 6-1: PIC16C54/CR54/C55 PROGRAM MEMORY MAP AND STACK

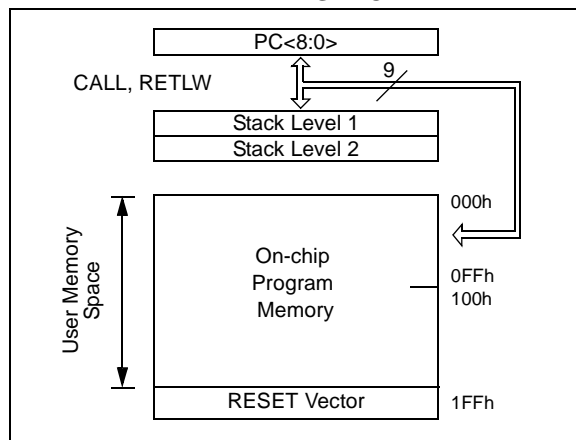


FIGURE 6-2: PIC16C56/CR56 PROGRAM MEMORY MAP AND STACK

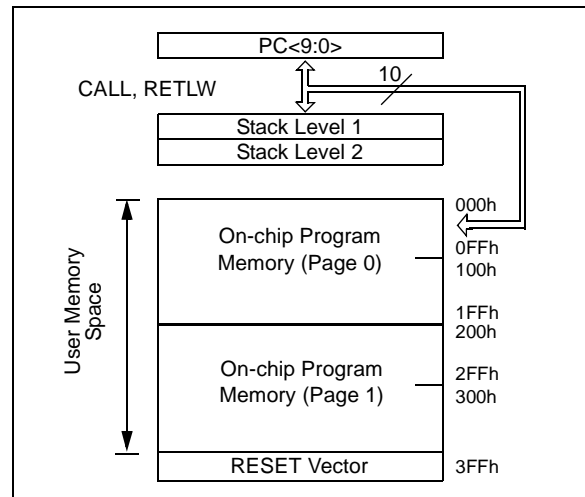
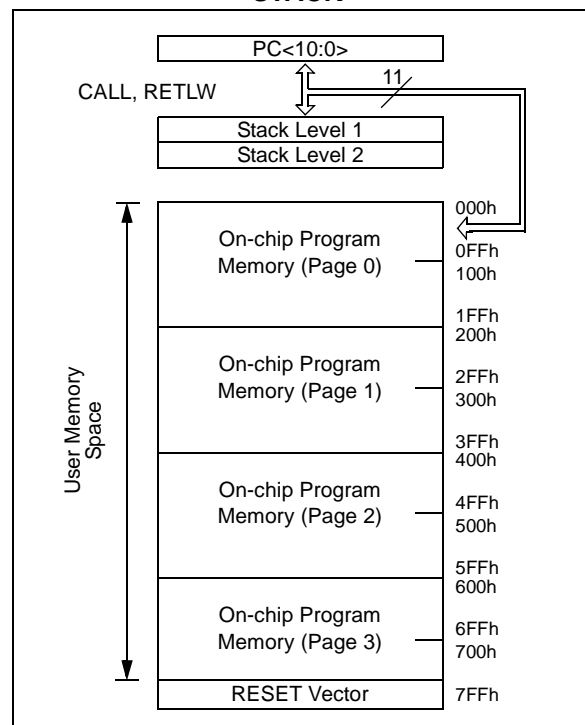


FIGURE 6-3: PIC16C57/CR57/C58/CR58 PROGRAM MEMORY MAP AND STACK



PIC16C5X

6.2 Data Memory Organization

Data memory is composed of registers, or bytes of RAM. Therefore, data memory for a device is specified by its register file. The register file is divided into two functional groups: Special Function Registers and General Purpose Registers.

The Special Function Registers include the TMR0 register, the Program Counter (PC), the Status Register, the I/O registers (ports) and the File Select Register (FSR). In addition, Special Purpose Registers are used to control the I/O port configuration and prescaler options.

The General Purpose Registers are used for data and control information under command of the instructions.

For the PIC16C54, PIC16CR54, PIC16C56 and PIC16CR56, the register file is composed of 7 Special Function Registers and 25 General Purpose Registers (Figure 6-4).

For the PIC16C55, the register file is composed of 8 Special Function Registers and 24 General Purpose Registers.

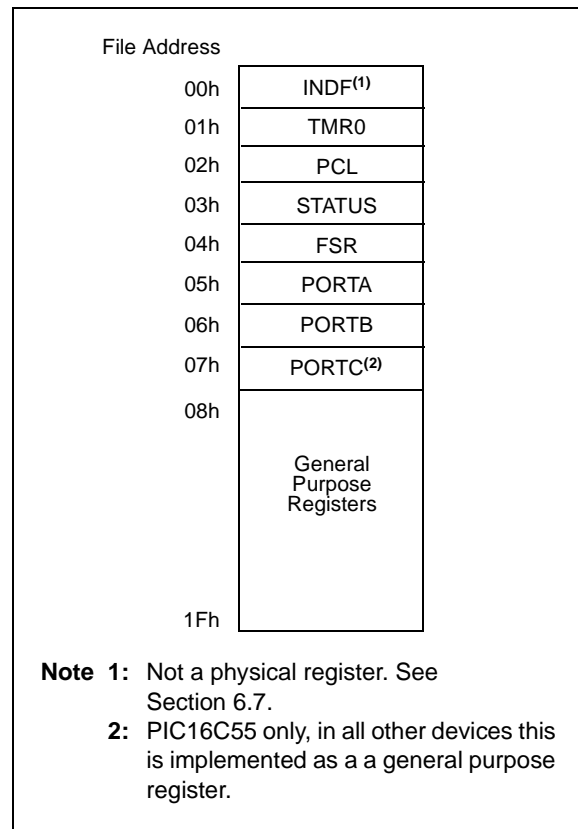
For the PIC16C57 and PIC16CR57, the register file is composed of 8 Special Function Registers, 24 General Purpose Registers and up to 48 additional General Purpose Registers that may be addressed using a banking scheme (Figure 6-5).

For the PIC16C58 and PIC16CR58, the register file is composed of 7 Special Function Registers, 25 General Purpose Registers and up to 48 additional General Purpose Registers that may be addressed using a banking scheme (Figure 6-6).

6.2.1 GENERAL PURPOSE REGISTER FILE

The register file is accessed either directly or indirectly through the File Select Register (FSR). The FSR Register is described in Section 6.7.

FIGURE 6-4: PIC16C54, PIC16CR54, PIC16C55, PIC16C56, PIC16CR56 REGISTER FILE MAP



8.2 Prescaler

An 8-bit counter is available as a prescaler for the Timer0 module, or as a postscaler for the Watchdog Timer (WDT), respectively (Section 9.2.1). For simplicity, this counter is being referred to as “prescaler” throughout this data sheet. Note that the prescaler may be used by either the Timer0 module or the WDT, but not both. Thus, a prescaler assignment for the Timer0 module means that there is no prescaler for the WDT, and vice-versa.

The PSA and PS<2:0> bits (OPTION<3:0>) determine prescaler assignment and prescale ratio.

When assigned to the Timer0 module, all instructions writing to the TMR0 register (e.g., CLRF 1, MOVWF 1, BSF 1,x, etc.) will clear the prescaler. When assigned to WDT, a CLRWDT instruction will clear the prescaler along with the WDT. The prescaler is neither readable nor writable. On a RESET, the prescaler contains all '0's.

8.2.1 SWITCHING PRESCALER ASSIGNMENT

The prescaler assignment is fully under software control (i.e., it can be changed “on the fly” during program execution). To avoid an unintended device RESET, the following instruction sequence (Example 8-1) must be executed when changing the prescaler assignment from Timer0 to the WDT.

EXAMPLE 8-1: CHANGING PRESCALER (TIMER0→WDT)

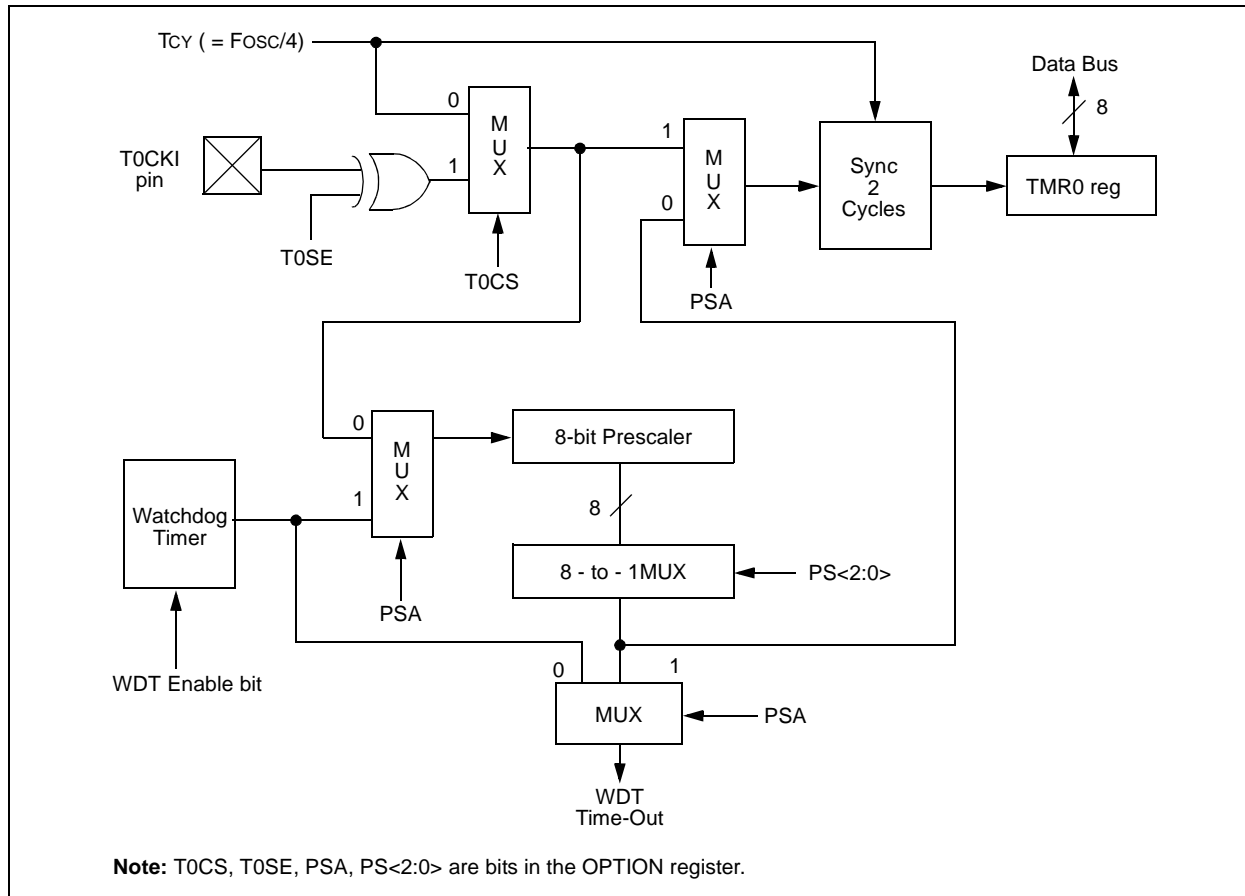
```
CLRWDT          ;Clear WDT
CLRF    TMR0     ;Clear TMR0 & Prescaler
MOVLW   B'00xx1111' ;Last 3 instructions in
                    ;this example
OPTION    ;are required only if
          ;desired
CLRWDT          ;PS<2:0> are 000 or
               ;001
MOVLW   B'00xx1xxx' ;Set Prescaler to
OPTION    ;desired WDT rate
```

To change prescaler from the WDT to the Timer0 module, use the sequence shown in Example 8-2. This sequence must be used even if the WDT is disabled. A CLRWDT instruction should be executed before switching the prescaler.

EXAMPLE 8-2: CHANGING PRESCALER (WDT→TIMER0)

```
CLRWDT          ;Clear WDT and
               ;prescaler
MOVLW   B'xxxx0xxx' ;Select TMR0, new
                   ;prescale value and
                   ;clock source
OPTION
```

FIGURE 8-6: BLOCK DIAGRAM OF THE TIMER0/WDT PRESCALER



PIC16C5X

9.1 Configuration Bits

Configuration bits can be programmed to select various device configurations. Two bits are for the selection of the oscillator type and one bit is the Watchdog Timer enable bit. Nine bits are code protection bits for the PIC16C54A, PIC16CR54A, PIC16C54C, PIC16CR54C, PIC16C55A, PIC16C56A, PIC16CR56A, PIC16C57C, PIC16CR57C,

PIC16C58B, and PIC16CR58B devices (Register 9-1). One bit is for code protection for the PIC16C54, PIC16C55, PIC16C56 and PIC16C57 devices (Register 9-2).

QTP or ROM devices have the oscillator configuration programmed at the factory and these parts are tested accordingly (see "Product Identification System" diagrams in the back of this data sheet).

REGISTER 9-1: CONFIGURATION WORD FOR PIC16C54A/CR54A/C54C/CR54C/C55A/C56A/CR56A/C57C/CR57C/C58B/CR58B

CP	CP	CP	CP	CP	CP	CP	CP	CP	WDTE	FOSC1	FOSC0
bit 11										bit 0	

bit 11-3: **CP**: Code Protection Bit

1 = Code protection off
0 = Code protection on

bit 2: **WDTE**: Watchdog timer enable bit

1 = WDT enabled
0 = WDT disabled

bit 1-0: **FOSC1:FOSC0**: Oscillator Selection Bit

00 = LP oscillator
01 = XT oscillator
10 = HS oscillator
11 = RC oscillator

Note 1: Refer to the PIC16C5X Programming Specification (Literature Number DS30190) to determine how to access the configuration word.

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

1 = bit is set

0 = bit is cleared

x = bit is unknown

9.3 Power-Down Mode (SLEEP)

A device may be powered down (SLEEP) and later powered up (Wake-up from SLEEP).

9.3.1 SLEEP

The Power-down mode is entered by executing a SLEEP instruction.

If enabled, the Watchdog Timer will be cleared but keeps running, the \overline{TO} bit (STATUS<4>) is set, the \overline{PD} bit (STATUS<3>) is cleared and the oscillator driver is turned off. The I/O ports maintain the status they had before the SLEEP instruction was executed (driving high, driving low, or hi-impedance).

It should be noted that a RESET generated by a WDT time-out does not drive the \overline{MCLR}/VPP pin low.

For lowest current consumption while powered down, the $T0CKI$ input should be at V_{DD} or V_{SS} and the \overline{MCLR}/VPP pin must be at a logic high level ($\overline{MCLR} = V_{IH}$).

9.3.2 WAKE-UP FROM SLEEP

The device can wake up from SLEEP through one of the following events:

1. An external RESET input on \overline{MCLR}/VPP pin.
2. A Watchdog Timer Time-out Reset (if WDT was enabled).

Both of these events cause a device RESET. The \overline{TO} and \overline{PD} bits can be used to determine the cause of device RESET. The \overline{TO} bit is cleared if a WDT time-out occurred (and caused wake-up). The \overline{PD} bit, which is set on power-up, is cleared when SLEEP is invoked.

The WDT is cleared when the device wakes from SLEEP, regardless of the wake-up source.

9.4 Program Verification/Code Protection

If the code protection bit(s) have not been programmed, the on-chip program memory can be read out for verification purposes.

Note: Microchip does not recommend code protecting windowed devices.

9.5 ID Locations

Four memory locations are designated as ID locations where the user can store checksum or other code-identification numbers. These locations are not accessible during normal execution but are readable and writable during program/verify.

Use only the lower 4 bits of the ID locations and always program the upper 8 bits as '1's.

Note: Microchip will assign a unique pattern number for QTP and SQTP requests and for ROM devices. This pattern number will be unique and traceable to the submitted code.

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NOTES:

CALL		Subroutine Call				
Syntax:	[<i>label</i>] CALL k					
Operands:	0 ≤ k ≤ 255					
Operation:	(PC) + 1 → TOS; k → PC<7:0>; (STATUS<6:5>) → PC<10:9>; 0 → PC<8>					
Status Affected:	None					
Encoding:	<table border="1"><tr><td>1001</td><td>kkkk</td><td>kkkk</td></tr></table>			1001	kkkk	kkkk
1001	kkkk	kkkk				
Description:	Subroutine call. First, return address (PC+1) is pushed onto the stack. The eight bit immediate address is loaded into PC bits <7:0>. The upper bits PC<10:9> are loaded from STATUS<6:5>, PC<8> is cleared. CALL is a two-cycle instruction.					
Words:	1					
Cycles:	2					
Example:	HERE CALL THERE					
Before Instruction						
PC = address (HERE)						
After Instruction						
PC = address (THERE)						
TOS = address (HERE + 1)						

CLRF	Clear f			
Syntax:	[<i>label</i>] CLRF f			
Operands:	$0 \leq f \leq 31$			
Operation:	00h \rightarrow (f); $1 \rightarrow Z$			
Status Affected:	Z			
Encoding:	<table border="1"><tr><td>0000</td><td>011f</td><td>ffff</td></tr></table>	0000	011f	ffff
0000	011f	ffff		
Description:	The contents of register 'f' are cleared and the Z bit is set.			
Words:	1			
Cycles:	1			
Example:	CLRF FLAG_REG			
Before Instruction				
FLAG_REG	= 0x5A			
After Instruction				
FLAG_REG	= 0x00			
Z	= 1			

CLR W				
Syntax:	[<i>label</i>] CLRW			
Operands:	None			
Operation:	00h → (W); 1 → Z			
Status Affected:	Z			
Encoding:	<table border="1"><tr><td>0000</td><td>0100</td><td>0000</td></tr></table>	0000	0100	0000
0000	0100	0000		
Description:	The W register is cleared. Zero bit (Z) is set.			
Words:	1			
Cycles:	1			
Example:	CLR W			
Before Instruction				
W	= 0x5A			
After Instruction				
W	= 0x00			
Z	= 1			

CLRWDWT		Clear Watchdog Timer				
Syntax:	[<i>label</i>] CLRWDWT					
Operands:	None					
Operation:	00h → WDT; 0 → WDT prescaler (if assigned); 1 → \overline{TO} ; 1 → \overline{PD}					
Status Affected:	\overline{TO} , \overline{PD}					
Encoding:	<table border="1"><tr><td>0000</td><td>0000</td><td>0100</td></tr></table>			0000	0000	0100
0000	0000	0100				
Description:	The CLRWDWT instruction resets the WDT. It also resets the prescaler, if the prescaler is assigned to the WDT and not Timer0. Status bits \overline{TO} and \overline{PD} are set.					
Words:	1					
Cycles:	1					
Example:	CLRWDWT					
Before Instruction						
WDT counter		=	?			
After Instruction						
WDT counter		=	0x00			
WDT prescaler		=	0			
\overline{TO}		=	1			
\overline{PD}		=	1			

MOVWF Move W to f

Syntax: [*label*] MOVWF f
 Operands: $0 \leq f \leq 31$
 Operation: $(W) \rightarrow (f)$
 Status Affected: None
 Encoding:

0000	001f	ffff
------	------	------

 Description: Move data from the W register to register 'f'.
 Words: 1
 Cycles: 1
 Example: MOVWF TEMP_REG

Before Instruction
 TEMP_REG = 0xFF
 W = 0x4F
 After Instruction
 TEMP_REG = 0x4F
 W = 0x4F

NOP No Operation

Syntax: [*label*] NOP
 Operands: None
 Operation: No operation
 Status Affected: None
 Encoding:

0000	0000	0000
------	------	------

 Description: No operation.
 Words: 1
 Cycles: 1
 Example: NOP

OPTION Load OPTION Register

Syntax: [*label*] OPTION
 Operands: None
 Operation: $(W) \rightarrow \text{OPTION}$
 Status Affected: None
 Encoding:

0000	0000	0010
------	------	------

 Description: The content of the W register is loaded into the OPTION register.
 Words: 1
 Cycles: 1
 Example: OPTION

Before Instruction
 W = 0x07
 After Instruction
 OPTION = 0x07

RETLW Return with Literal in W

Syntax: [*label*] RETLW k
 Operands: $0 \leq k \leq 255$
 Operation: $k \rightarrow (W)$;
 TOS \rightarrow PC
 Status Affected: None
 Encoding:

1000	kkkk	kkkk
------	------	------

 Description: The W register is loaded with the eight bit literal 'k'. The program counter is loaded from the top of the stack (the return address). This is a two-cycle instruction.
 Words: 1
 Cycles: 2
 Example: CALL TABLE ;W contains
 ;table offset
 ;value.
 • ;W now has table
 • ;value.
 TABLE •
 ADDWF PC ;W = offset
 RETLW k1 ;Begin table
 RETLW k2 ;
 •
 •
 •
 RETLW kn ; End of table

Before Instruction
 W = 0x07
 After Instruction
 W = value of k8

PIC16C5X

RLF Rotate Left f through Carry

Syntax: [label] RLF f,d

Operands: $0 \leq f \leq 31$
 $d \in [0,1]$

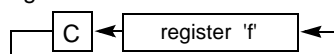
Operation: See description below

Status Affected: C

Encoding:

0011	01df	ffff
------	------	------

Description: The contents of register 'f' are rotated one bit to the left through the Carry Flag (STATUS<0>). If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is stored back in register 'f'.



Words: 1

Cycles: 1

Example: RLF REG1,0

Before Instruction

REG1 = 1110 0110

C = 0

After Instruction

REG1 = 1110 0110

W = 1100 1100

C = 1

RRF Rotate Right f through Carry

Syntax: [label] RRF f,d

Operands: $0 \leq f \leq 31$
 $d \in [0,1]$

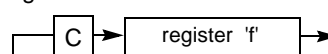
Operation: See description below

Status Affected: C

Encoding:

0011	00df	ffff
------	------	------

Description: The contents of register 'f' are rotated one bit to the right through the Carry Flag (STATUS<0>). If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'.



Words: 1

Cycles: 1

Example: RRF REG1,0

Before Instruction

REG1 = 1110 0110

C = 0

After Instruction

REG1 = 1110 0110

W = 0111 0011

C = 0

SLEEP Enter SLEEP Mode

Syntax: [label] SLEEP

Operands: None

Operation: 00h → WDT;
 0 → WDT prescaler; if assigned
 1 → \overline{TO} ;
 0 → \overline{PD}

Status Affected: \overline{TO} , \overline{PD}

Encoding:

0000	0000	0011
------	------	------

Description: Time-out status bit (\overline{TO}) is set. The power-down status bit (\overline{PD}) is cleared. The WDT and its prescaler are cleared.
 The processor is put into SLEEP mode with the oscillator stopped. See section on SLEEP for more details.

Words: 1

Cycles: 1

Example: SLEEP

SUBWF Subtract W from f

Syntax: `[label] SUBWF f,d`

Operands: $0 \leq f \leq 31$
 $d \in [0,1]$

Operation: $(f) - (W) \rightarrow (\text{dest})$

Status Affected: C, DC, Z

Encoding:

0000	10df	ffff
------	------	------

Description: Subtract (2's complement method) the W register from register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.

Words: 1

Cycles: 1

Example 1: `SUBWF REG1, 1`

Before Instruction
 REG1 = 3
 W = 2
 C = ?

After Instruction
 REG1 = 1
 W = 2
 C = 1 ; result is positive

Example 2:

Before Instruction
 REG1 = 2
 W = 2
 C = ?

After Instruction
 REG1 = 0
 W = 2
 C = 1 ; result is zero

Example 3:

Before Instruction
 REG1 = 1
 W = 2
 C = ?

After Instruction
 REG1 = 0xFF
 W = 2
 C = 0 ; result is negative

SWAPF Swap Nibbles in f

Syntax: `[label] SWAPF f,d`

Operands: $0 \leq f \leq 31$
 $d \in [0,1]$

Operation: $(f<3:0>) \rightarrow (\text{dest}<7:4>);$
 $(f<7:4>) \rightarrow (\text{dest}<3:0>)$

Status Affected: None

Encoding:

0011	10df	ffff
------	------	------

Description: The upper and lower nibbles of register 'f' are exchanged. If 'd' is 0 the result is placed in W register. If 'd' is 1 the result is placed in register 'f'.

Words: 1

Cycles: 1

Example `SWAPF REG1, 0`

Before Instruction
 REG1 = 0xA5

After Instruction
 REG1 = 0xA5
 W = 0x5A

TRIS Load TRIS Register

Syntax: `[label] TRIS f`

Operands: $f = 5, 6 \text{ or } 7$

Operation: $(W) \rightarrow \text{TRIS register } f$

Status Affected: None

Encoding:

0000	0000	0fff
------	------	------

Description: TRIS register 'f' ($f = 5, 6, \text{ or } 7$) is loaded with the contents of the W register.

Words: 1

Cycles: 1

Example `TRIS PORTB`

Before Instruction
 W = 0xA5

After Instruction
 TRISB = 0xA5

FIGURE 14-2: TYPICAL RC OSC FREQUENCY vs. VDD, CEXT = 20 PF

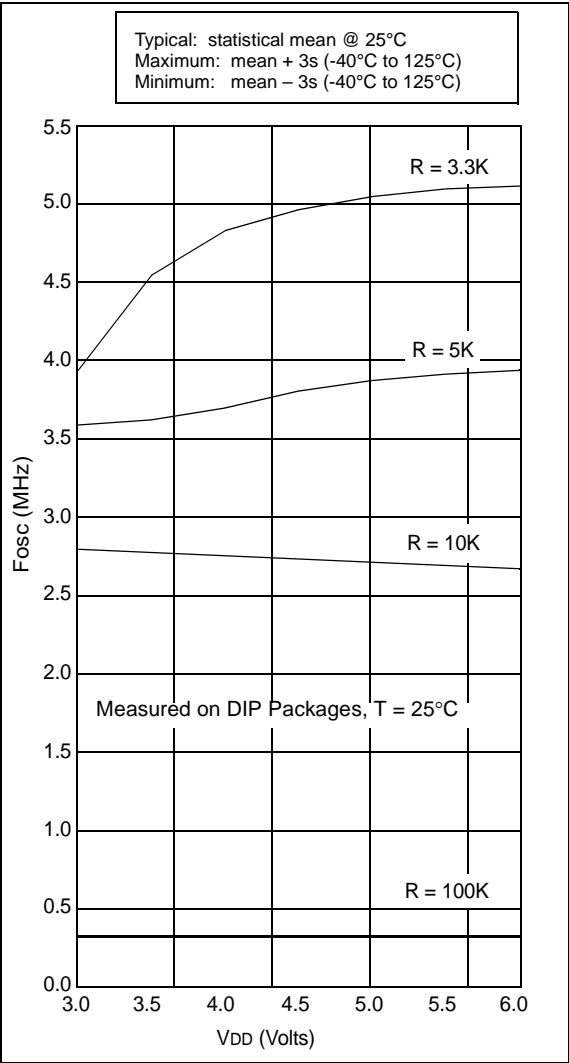


FIGURE 14-3: TYPICAL RC OSC FREQUENCY vs. VDD, CEXT = 100 PF

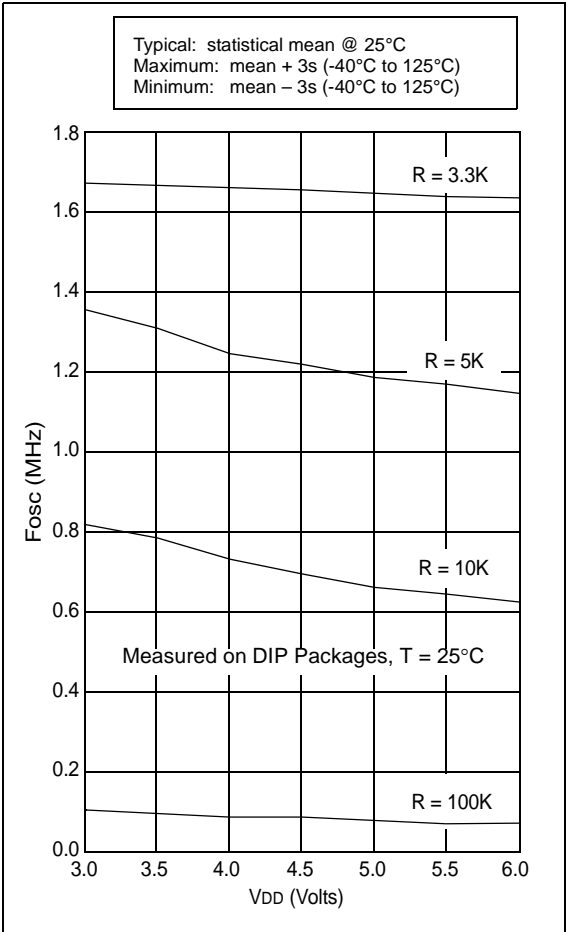


FIGURE 16-18: TRANSCONDUCTANCE (gm) OF LP OSCILLATOR vs. VDD

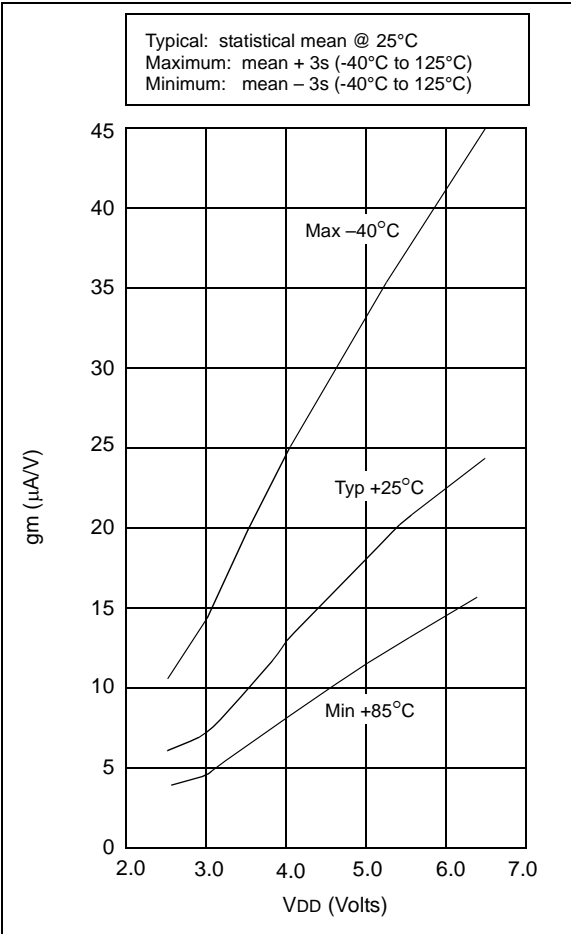
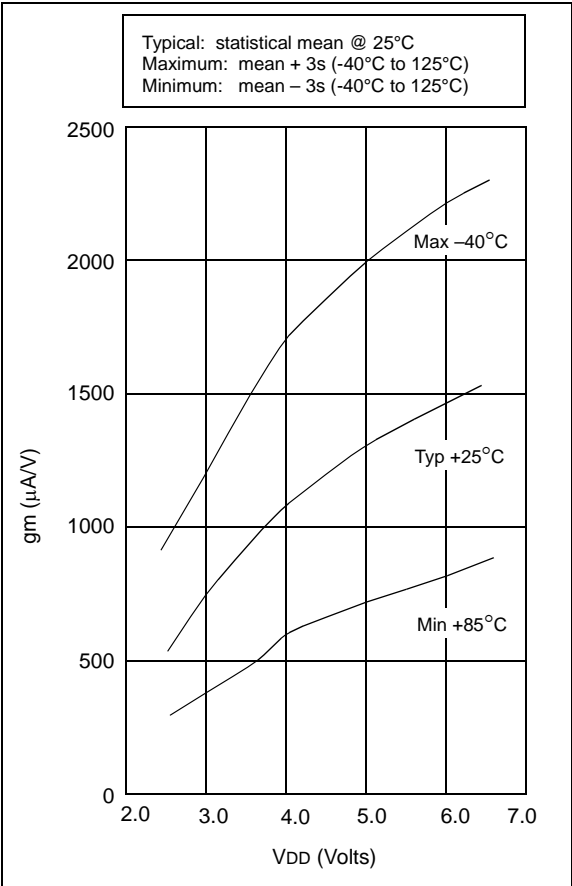


FIGURE 16-19: TRANSCONDUCTANCE (gm) OF XT OSCILLATOR vs. VDD



PIC16C5X

NOTES:

17.4 Timing Parameter Symbolology and Load Conditions

The timing parameter symbols have been created with one of the following formats:

- 1. TppS2ppS
- 2. TppS

T			
F	Frequency	T	Time
Lowercase letters (pp) and their meanings:			
pp		mc	MCLR
2	to	osc	oscillator
ck	CLKOUT	os	OSC1
cy	cycle time	t0	T0CKI
drt	device reset timer	wdt	watchdog timer
io	I/O port		
Uppercase letters and their meanings:			
S		P	Period
F	Fall	R	Rise
H	High	V	Valid
I	Invalid (Hi-impedance)	Z	Hi-impedance
L	Low		

FIGURE 17-5: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS - PIC16C54C/CR54C/C55A/C56A/CR56A/C57C/CR57C/C58B/CR58B-04, 20

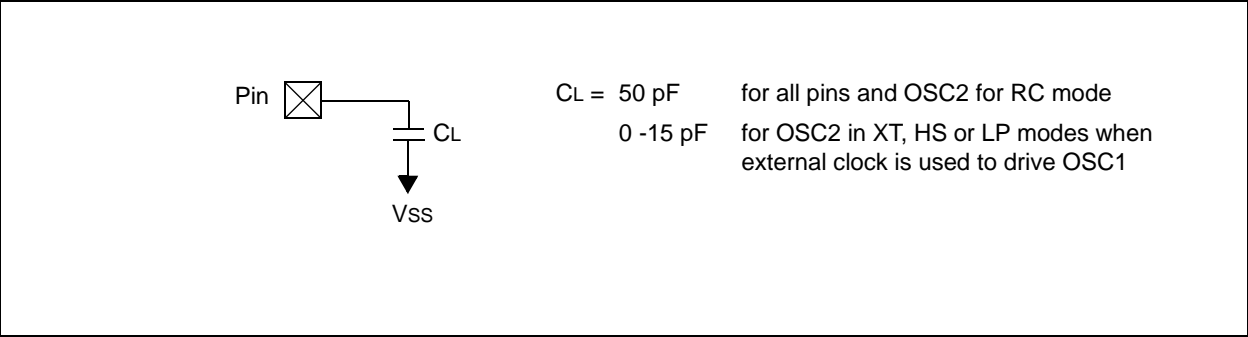


FIGURE 19-4: CLKOUT AND I/O TIMING - PIC16C5X-40

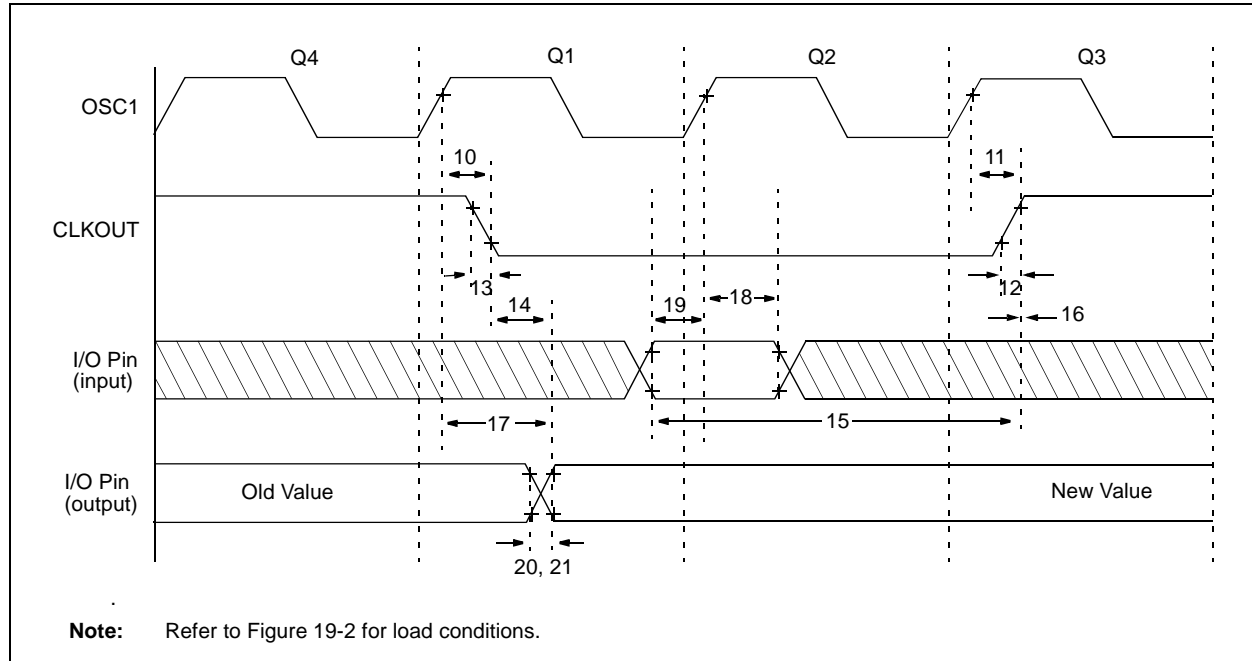


TABLE 19-2: CLKOUT AND I/O TIMING REQUIREMENTS - PIC16C5X-40

AC Characteristics		Standard Operating Conditions (unless otherwise specified) Operating Temperature 0°C ≤ TA ≤ +70°C for commercial				
Param No.	Symbol	Characteristic	Min	Typ†	Max	Units
10	TosH2ckL	OSC1↑ to CLKOUT↓ ^(1,2)	—	15	30**	ns
11	TosH2ckH	OSC1↑ to CLKOUT↑ ^(1,2)	—	15	30**	ns
12	TckR	CLKOUT rise time ^(1,2)	—	5.0	15**	ns
13	TckF	CLKOUT fall time ^(1,2)	—	5.0	15**	ns
14	TckL2ioV	CLKOUT↓ to Port out valid ^(1,2)	—	—	40**	ns
15	TioV2ckH	Port in valid before CLKOUT↑ ^(1,2)	0.25 TCY+30*	—	—	ns
16	TckH2ioI	Port in hold after CLKOUT↑ ^(1,2)	0*	—	—	ns
17	TosH2ioV	OSC1↑ (Q1 cycle) to Port out valid ⁽²⁾	—	—	100	ns
18	TosH2ioI	OSC1↑ (Q2 cycle) to Port input invalid (I/O in hold time)	TBD	—	—	ns
19	TioV2osH	Port input valid to OSC1↑ (I/O in setup time)	TBD	—	—	ns
20	TioR	Port output rise time ⁽²⁾	—	10	25**	ns
21	TioF	Port output fall time ⁽²⁾	—	10	25**	ns

* These parameters are characterized but not tested.

** These parameters are design targets and are not tested. No characterization data available at this time.

† Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Measurements are taken in RC Mode where CLKOUT output is 4 x TOSC.

2: Refer to Figure 19-2 for load conditions.

FIGURE 20-6: TYPICAL I_{DD} vs. V_{DD} (40 MHZ, WDT DISABLED, HS MODE, 70°C)

